

In re application of:

TALIEH et al.

Serial No.: 09/941,360

Filed: August 28, 2001

Title: Method And Apparatus For Plating and

Polishing A Semiconductor Substrate

Group Art Unit: 1742 Examiner: D. Valentine Docket: NT-004D-US

CERTIFICATE OF MAILING

I hereby certify that this correspondence is deposited with the US Postal Service as First Glass Mail

in a postage-paid envelope addressed to the Commissioner for Patents, P.O. Box/1450/Alexandria,

VA 22313 on October 22, 2003

Signed:

Nwine

AMENDMENT A

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313

Dear Sir:

In response to the Office Action mailed July 2, 2003, Applicants petition for a one-month extension to the shortened statutory period response and asserts small entity status in an accompanying paper. A PTO-2038 form for \$55 is included to cover the one-month extension fee. Applicants request entry and consideration of the following Remarks and Amendment. Please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 5 of this paper.